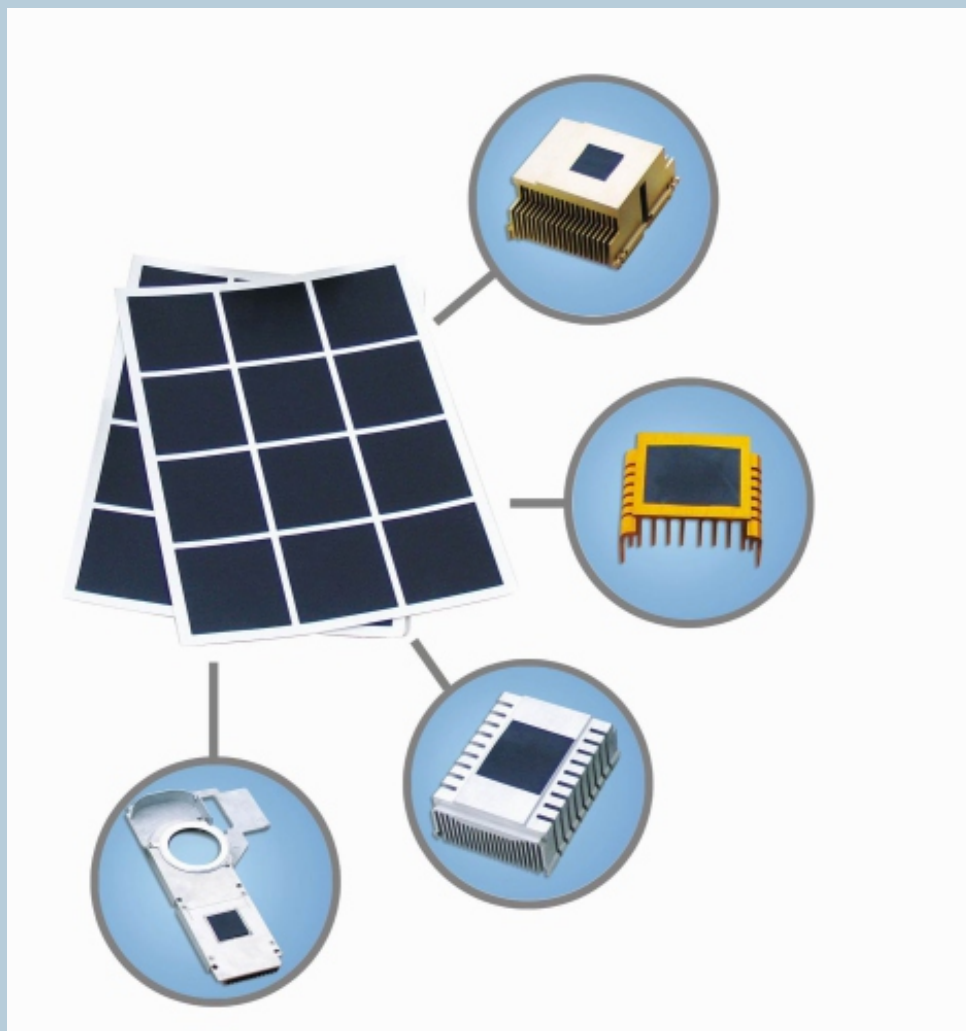


# Journal of Electronics Cooling and Thermal Control



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# Table of Contents

Volume 5    Number 2

June 2015

**CFD Study of Forced Air Cooling and Windage Losses in a High Speed Electric Motor**

K. R. Anderson, J. Lin, C. McNamara, V. Magri.....27

---

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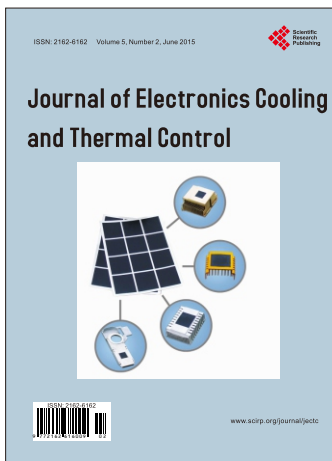
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**Journal of Electronics Cooling and Thermal Control (JECTC)** is a quarterly, peer-reviewed, academic journal. It aims to provide a vehicle for the exchange and dissemination of original research results, technical notes, and state-of-the-art reviews pertaining to the electronic cooling and thermal system control technology in the computer and electronics industries.

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